

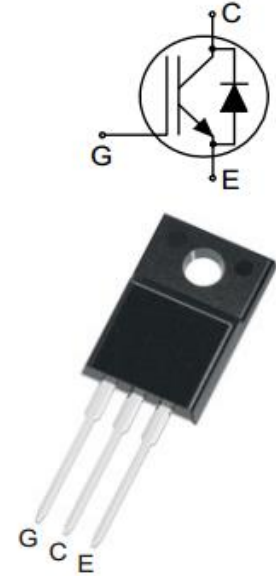
IGBT

Features

- 650V,15A
- $V_{CE(sat)(typ.)}=1.6V@V_{GE}=15V,I_C=15A$
- High ruggedness performance
- 10 μ s short circuit capability
- High efficiency for motor control
- Excellent current sharing in parallel operation

Applications

- Home appliances
- Motor drives
- General inverter



Absolute Maximum Ratings

| Symbol | Parameter | Value | Units |
|-----------|--|-------------|------------|
| V_{CES} | Collector-Emitter Voltage | 650 | V |
| V_{GES} | Gate-Emitter Voltage | ± 20 | V |
| I_C | Continuous Collector Current ($T_C=25^\circ C$) | 30 | A |
| | Continuous Collector Current ($T_C=100^\circ C$) | 15 | A |
| I_{CM} | Pulsed Collector Current (Note 1) | 60 | A |
| I_F | Diode Continuous Forward Current ($T_C=100^\circ C$) | 15 | A |
| I_{FM} | Diode Maximum Forward Current (Note 1) | 60 | A |
| t_{sc} | Short Circuit Withstand Time | 10 | us |
| P_D | Maximum Power Dissipation ($T_C=25^\circ C$) | 39 | W |
| | Maximum Power Dissipation ($T_C=100^\circ C$) | 19 | W |
| T_J | Operating Junction Temperature Range | -40 to +175 | $^\circ C$ |
| T_{STG} | Storage Temperature Range | -55 to +150 | $^\circ C$ |

Thermal Characteristics

| Symbol | Parameter | Max. | Units |
|---------------|--|------|--------------|
| $R_{th\ j-c}$ | Thermal Resistance, Junction to case for IGBT | 3.8 | $^\circ C/W$ |
| $R_{th\ j-c}$ | Thermal Resistance, Junction to case for Diode | 4.2 | $^\circ C/W$ |
| $R_{th\ j-a}$ | Thermal Resistance, Junction to Ambient | 50 | $^\circ C/W$ |

Electrical Characteristics ($T_C=25^{\circ}\text{C}$ unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units | |
|---------------|--------------------------------------|--|--------------|------|-----------|---------|----|
| BV_{CES} | Collector-Emitter Breakdown Voltage | $V_{GE}=0V, I_C=250\mu A$ | 650 | - | - | V | |
| I_{CES} | Collector-Emitter Leakage Current | $V_{CE}=650V, V_{GE}=0V$ | - | - | 50 | μA | |
| I_{GES} | Gate Leakage Current, Forward | $V_{GE}=\pm 20V, V_{CE}=0V$ | - | - | ± 100 | nA | |
| $V_{GE(th)}$ | Gate Threshold Voltage | $V_{GE}=V_{CE}, I_C=1mA$ | 5.4 | 5.6 | 5.9 | V | |
| $V_{CE(sat)}$ | Collector-Emitter Saturation Voltage | $V_{GE}=15V, I_C=15A$ | - | 1.6 | - | V | |
| Q_g | Total Gate Charge | $V_{CC}=520V$ $V_{GE}=15V$ $I_C=15A$ | - | 55 | - | nC | |
| $t_{d(on)}$ | Turn-on Delay Time | $V_{CC}=400V$ $V_{GE}=15V$ $I_C=15A$ $R_G=10\Omega$ Inductive Load $T_C=25^{\circ}\text{C}$ | - | 17 | - | ns | |
| t_r | Turn-on Rise Time | | - | 14 | - | ns | |
| $t_{d(off)}$ | Turn-off Delay Time | | - | 104 | - | ns | |
| t_f | Turn-off Fall Time | | - | 46 | - | ns | |
| E_{on} | Turn-on Switching Loss | | - | 0.30 | - | mJ | |
| E_{off} | Turn-off Switching Loss | | - | 0.27 | - | mJ | |
| E_{ts} | Total Switching Loss | | - | 0.57 | - | mJ | |
| C_{ies} | Input Capacitance | | $V_{CE}=30V$ | - | 1055 | - | pF |
| C_{oes} | Output Capacitance | | $V_{GE}=0V$ | - | 57 | - | pF |
| C_{res} | Reverse Transfer Capacitance | $f=1MHz$ | - | 15 | - | pF | |

Electrical Characteristics of Diode ($T_C=25^{\circ}\text{C}$ unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|----------|-------------------------------------|--------------------|------|------|------|-------|
| V_F | Diode Forward Voltage | $I_F=15A$ | - | 1.4 | - | V |
| t_{rr} | Diode Reverse Recovery Time | $V_{CE}=400V$ | - | 55 | - | ns |
| I_{rr} | Diode peak Reverse Recovery Current | $I_F=15A$ | - | 9.5 | - | A |
| Q_{rr} | Diode Reverse Recovery Charge | $di/dt=600A/\mu s$ | - | 220 | - | nC |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

Typical Performance Characteristics

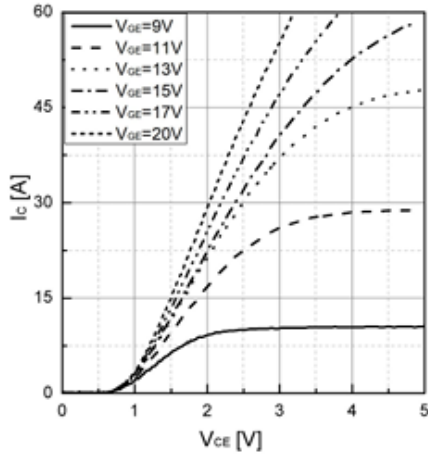


Fig 1. Typical output characteristic ($T_{vj}=25^{\circ}\text{C}$)

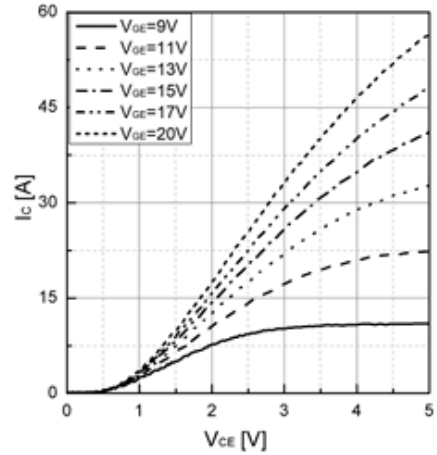


Fig 2. Typical output characteristic ($T_{vj}=175^{\circ}\text{C}$)

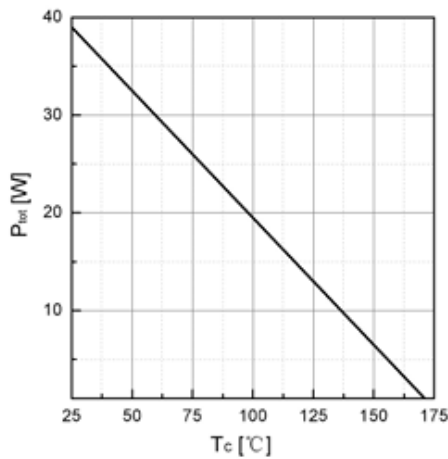


Fig 3. Power dissipation as a function of T_c

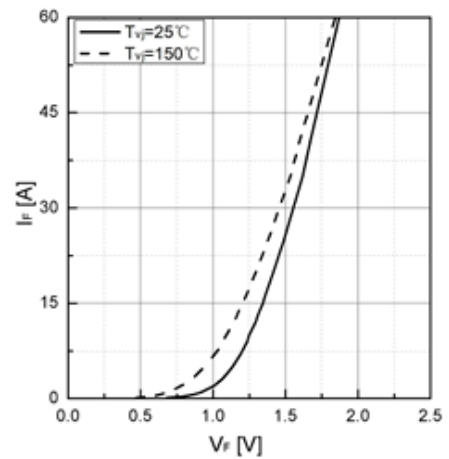


Fig 4. Typical I_F as a function of V_F

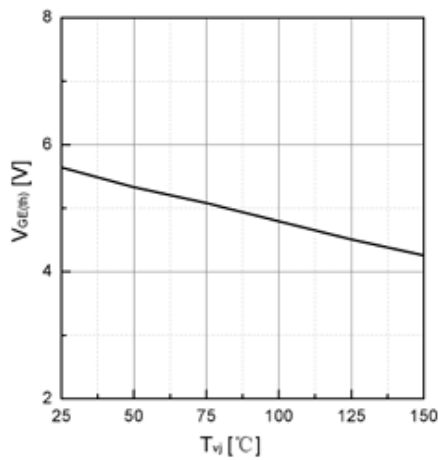


Fig 5. Typical $V_{GE(th)}$ as a function of T_{vj}
($I_C=1\text{mA}$)

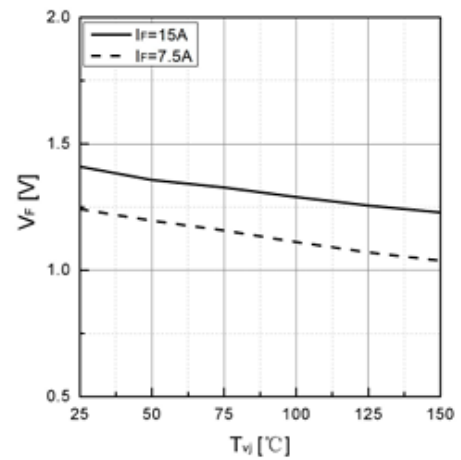


Fig 6. Typical V_F as a function of T_{vj}

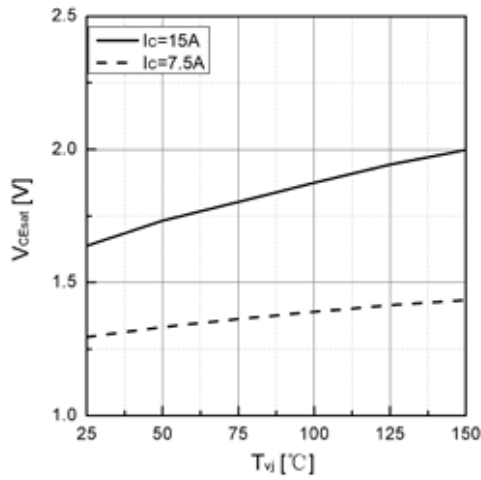


Fig 7. Typical V_{CEsat} as a function of T_{vj}

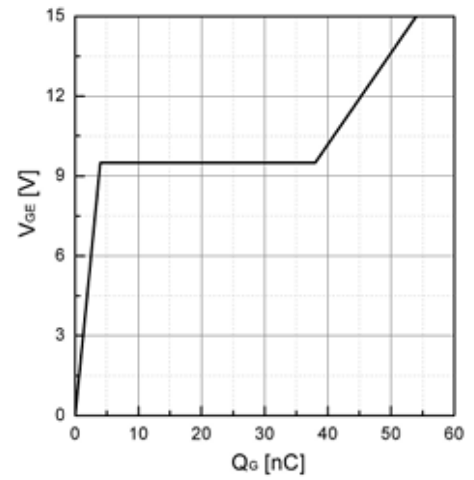


Fig 8. Typical Gate charge

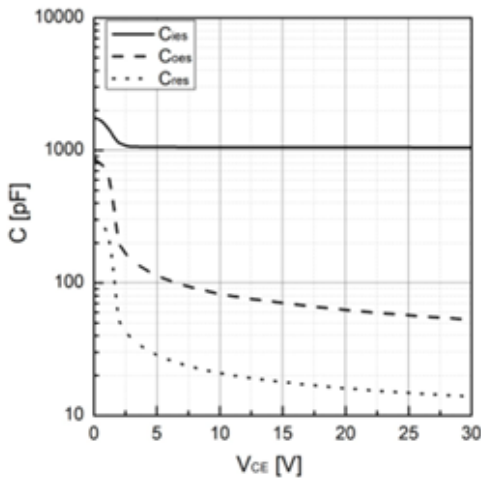


Fig 9. Typical capacitance as a function of V_{CE}
($f=1\text{MHz}$, $V_{GE}=0\text{V}$)

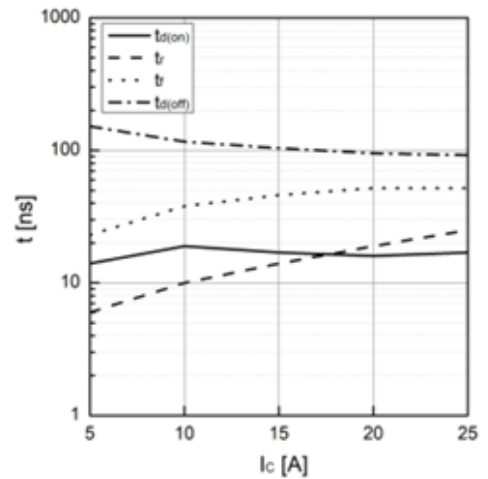


Fig 10. Typical switching times as a function of I_c

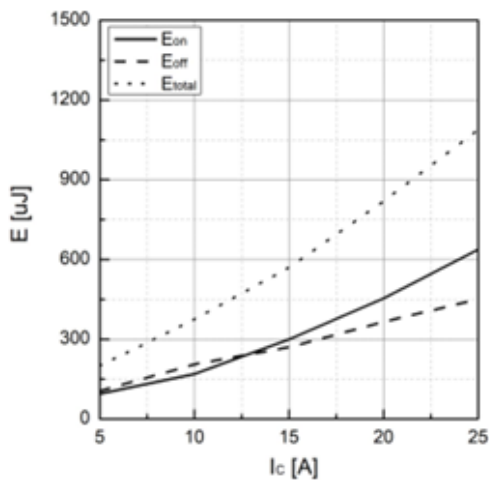


Fig 11. Typical switching energy losses as a function of I_c

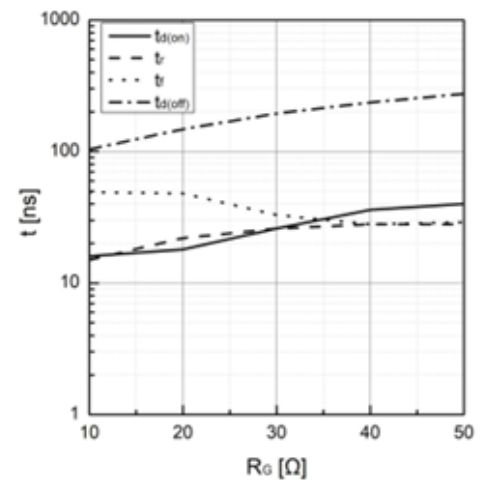


Fig 12. Typical switching times as a function of R_G

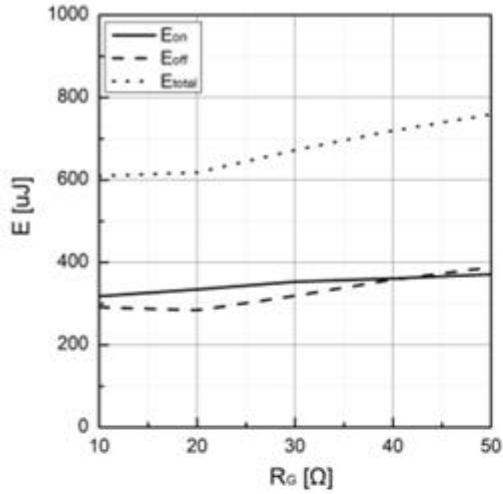


Fig 13. Typical switching energy losses as a function of R_G

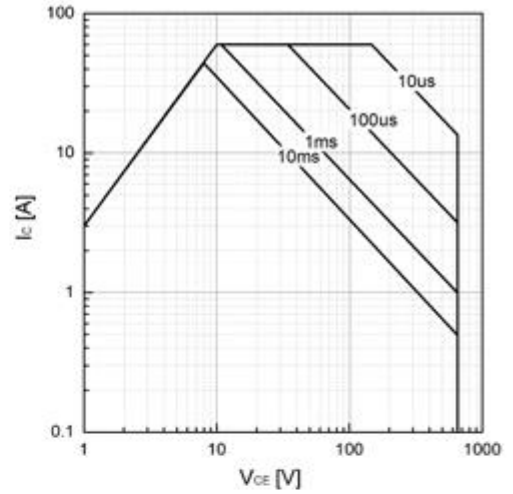


Fig 14. Safe operating area

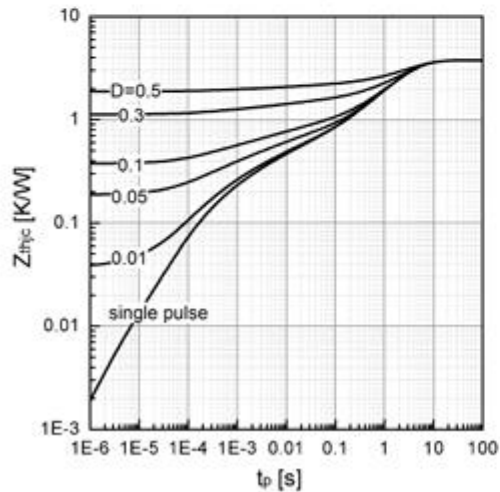
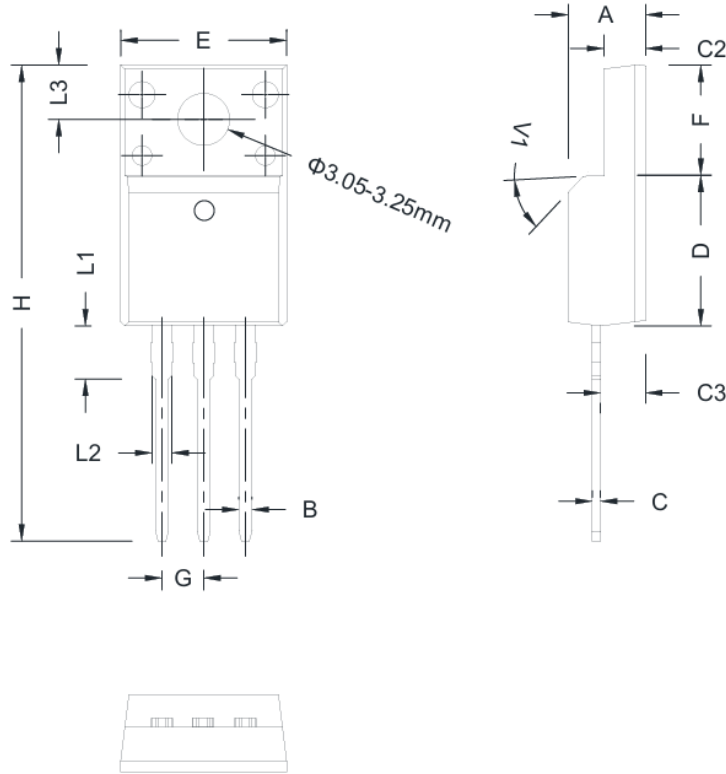


Fig 15. Transient thermal impedance, IGBT

TO-220F PACKAGE OUTLINE



| Ref. | Dimensions | | | | | |
|------|-------------|------|-------|--------|-------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 4.50 | - | 4.90 | 0.177 | - | 0.193 |
| B | 0.74 | 0.80 | 0.83 | 0.029 | 0.031 | 0.033 |
| C | 0.47 | - | 0.66 | 0.019 | - | 0.026 |
| C2 | 2.45 | - | 2.75 | 0.096 | - | 0.108 |
| C3 | 2.60 | - | 3.00 | 0.102 | - | 0.118 |
| D | 8.80 | - | 9.30 | 0.346 | - | 0.366 |
| E | 9.80 | - | 10.40 | 0.386 | - | 0.410 |
| F | 6.40 | - | 6.80 | 0.252 | - | 0.268 |
| G | 2.40 | - | 2.70 | 0.094 | - | 0.106 |
| H | 28.0 | - | 29.80 | 1.102 | - | 1.173 |
| L1 | - | 3.63 | - | - | 0.143 | - |
| L2 | 1.14 | - | 1.70 | 0.045 | - | 0.067 |
| L3 | - | 3.30 | - | - | 0.130 | - |
| V1 | - | 45° | - | - | 45° | - |

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